

**GSS4913**

P-CHANNEL ENHANCEMENT MODE POWER MOSFET

|                   |       |
|-------------------|-------|
| BV <sub>DSS</sub> | -20V  |
| R <sub>DSON</sub> | 130mΩ |
| I <sub>D</sub>    | -3.5A |

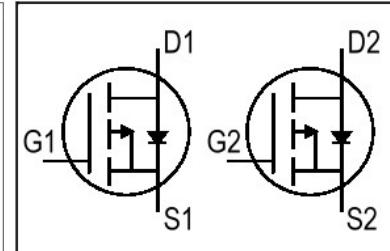
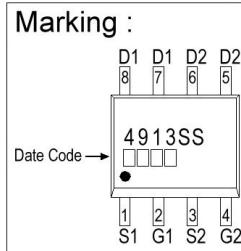
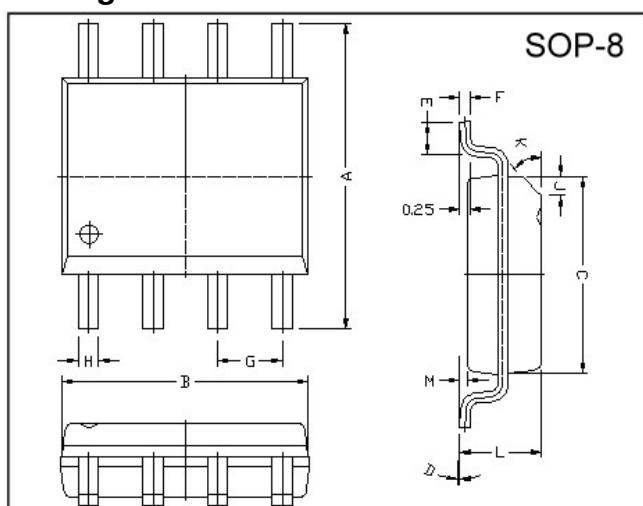
**Description**

The GSS4913 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOP-8 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

**Features**

- \*Simple Drive Requirement
- \*Low On-resistance
- \*Fast Switching Speed

**Package Dimensions**

| REF. | Millimeter |      | REF. | Millimeter |      |
|------|------------|------|------|------------|------|
|      | Min.       | Max. |      | Min.       | Max. |
| A    | 5.80       | 6.20 | M    | 0.10       | 0.25 |
| B    | 4.80       | 5.00 | H    | 0.35       | 0.49 |
| C    | 3.80       | 4.00 | L    | 1.35       | 1.75 |
| D    | 0°         | 8°   | J    | 0.375 REF. |      |
| E    | 0.40       | 0.90 | K    | 45°        |      |
| F    | 0.19       | 0.25 | G    | 1.27 TYP.  |      |

**Absolute Maximum Ratings**

| Parameter  | Symbol                            | Ratings    | Unit |
|--|-----------------------------------|------------|------|
| Drain-Source Voltage                             | V <sub>DS</sub>                   | -20        | V    |
| Gate-Source Voltage                              | V <sub>GS</sub>                   | ±8         | V    |
| Continuous Drain Current <sup>3</sup>            | I <sub>D</sub> @TA=25°C           | -3.5       | A    |
| Continuous Drain Current <sup>3</sup>            | I <sub>D</sub> @TA=70°C           | -2.8       | A    |
| Pulsed Drain Current <sup>1,2</sup>              | I <sub>DM</sub>                   | -18        | A    |
| Total Power Dissipation                          | P <sub>D</sub> @TA=25°C           | 2          | W    |
| Linear Derating Factor                           |                                   | 0.02       | W/°C |
| Operating Junction and Storage Temperature Range | T <sub>j</sub> , T <sub>stg</sub> | -55 ~ +150 | °C   |

**Thermal Data**

| Parameter   | Symbol             | Value | Unit |
|---|--------------------|-------|------|
| Thermal Resistance Junction-ambient <sup>3</sup> Max. | R <sub>thj-a</sub> | 62.5  | °C/W |

## Electrical Characteristics ( $T_j = 25^\circ\text{C}$ unless otherwise specified)

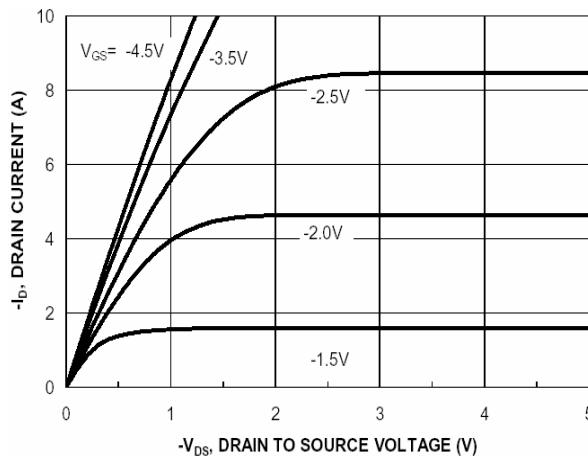
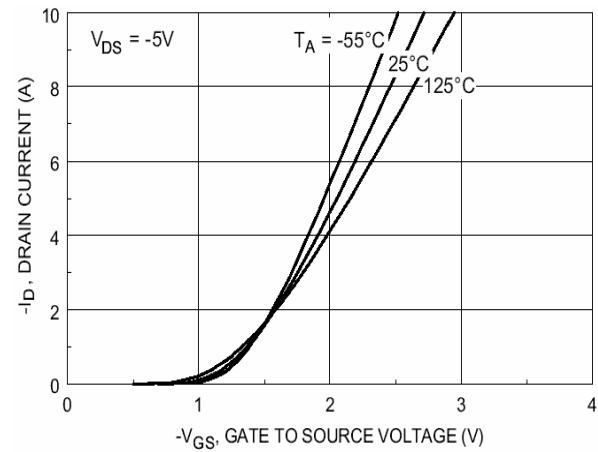
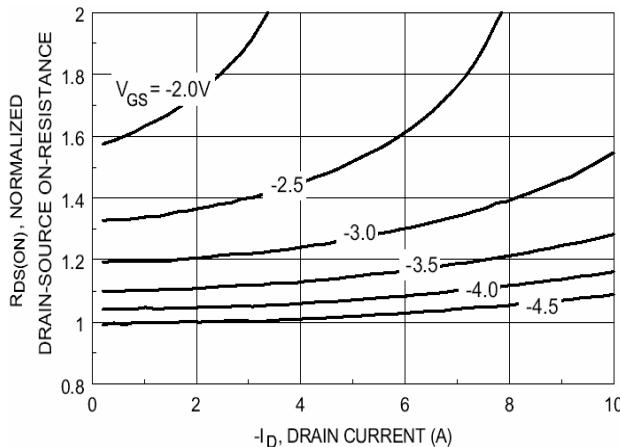
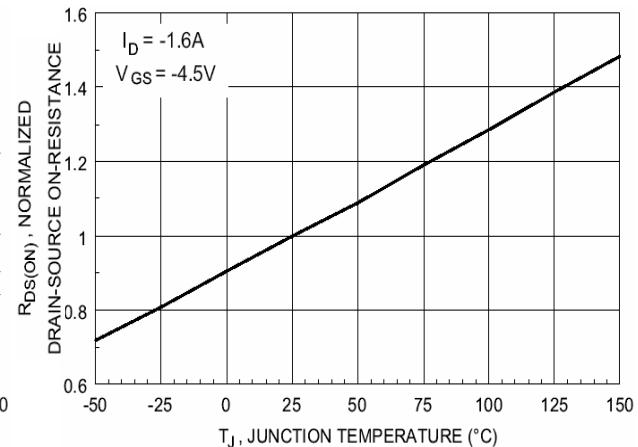
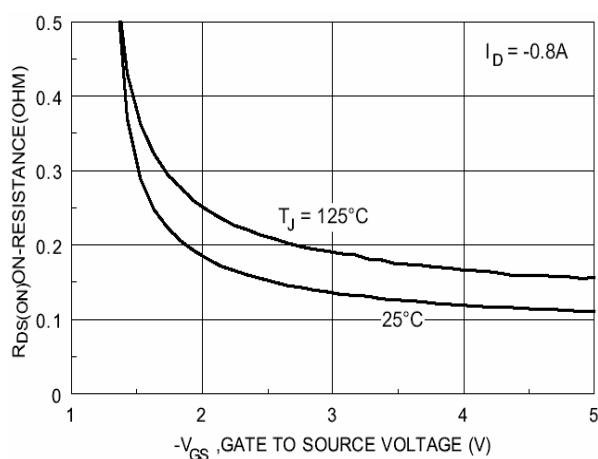
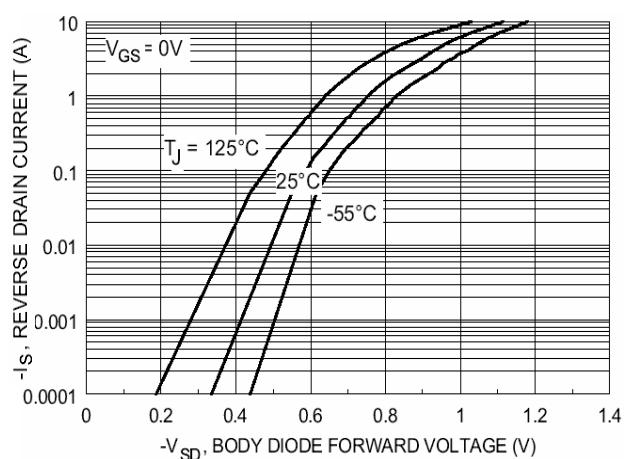
| Parameter  | Symbol                                       | Min. | Typ.   | Max.      | Unit                | Test Conditions   |
|--|--|------|--------|-----------|---------------------|---|
| Drain-Source Breakdown Voltage                         | $\text{BV}_{\text{DSS}}$                     | -20  | -      | -         | V                   | $\text{V}_{\text{GS}}=0, \text{I}_D=-250\mu\text{A}$  |
| Breakdown Voltage Temperature Coefficient              | $\Delta \text{BV}_{\text{DSS}} / \Delta T_j$ | -    | -0.028 | -         | V/ $^\circ\text{C}$ | Reference to $25^\circ\text{C}$ , $\text{I}_D=-250\mu\text{A}$  |
| Gate Threshold Voltage                                 | $\text{V}_{\text{GS}(\text{th})}$            | -0.4 | -      | -1.0      | V                   | $\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=-250\mu\text{A}$   |
| Forward Transconductance                               | $\text{g}_{\text{fs}}$                       | -    | 6.5    | -         | S                   | $\text{V}_{\text{DS}}=-5\text{V}, \text{I}_D=-3.5\text{A}$  |
| Gate-Source Leakage Current                            | $\text{I}_{\text{GSS}}$                      | -    | -      | $\pm 100$ | nA                  | $\text{V}_{\text{GS}}= \pm 8\text{V}$   |
| Drain-Source Leakage Current( $T_j=25^\circ\text{C}$ ) | $\text{I}_{\text{DSS}}$                      | -    | -      | -1        | uA                  | $\text{V}_{\text{DS}}=-16\text{V}, \text{V}_{\text{GS}}=0$  |
| Drain-Source Leakage Current( $T_j=70^\circ\text{C}$ ) |  | -    | -      | -25       | uA                  | $\text{V}_{\text{DS}}=-12\text{V}, \text{V}_{\text{GS}}=0$  |
| Static Drain-Source On-Resistance                      | $\text{R}_{\text{DS}(\text{ON})}$            | -    | -      | 130       | m $\Omega$          | $\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_D=-3.5\text{A}$  |
|  |  | -    | -      | 180       |                     | $\text{V}_{\text{GS}}=-2.5\text{V}, \text{I}_D=-3.0\text{A}$  |
| Total Gate Charge <sup>2</sup>                         | $\text{Q}_g$                                 | -    | 6      | 8.5       | nC                  | $\text{I}_D=-3.5\text{A}$<br>$\text{V}_{\text{DS}}=-5\text{V}$<br>$\text{V}_{\text{GS}}=-4.5\text{V}$                       |
| Gate-Source Charge                                     | $\text{Q}_{\text{gs}}$                       | -    | 0.8    | -         |                     |   |
| Gate-Drain ("Miller") Change                           | $\text{Q}_{\text{gd}}$                       | -    | 1.3    | -         |                     |   |
| Turn-on Delay Time <sup>2</sup>                        | $\text{T}_{\text{d}(\text{on})}$             | -    | 6.5    | -         | ns                  | $\text{V}_{\text{DD}}=-5\text{V}$<br>$\text{I}_D=-1\text{A}$<br>$\text{V}_{\text{GS}}=-4.5\text{V}$<br>$\text{R}_G=6\Omega$ |
| Rise Time  | $\text{T}_r$                                 | -    | 20     | -         |                     |   |
| Turn-off Delay Time                                    | $\text{T}_{\text{d}(\text{off})}$            | -    | 31     | -         |                     |   |
| Fall Time  | $\text{T}_f$                                 | -    | 21     | -         |                     |   |
| Input Capacitance                                      | $\text{C}_{\text{iss}}$                      | -    | 405    | -         | pF                  | $\text{V}_{\text{GS}}=0\text{V}$<br>$\text{V}_{\text{DS}}=-10\text{V}$<br>$f=1.0\text{MHz}$                                 |
| Output Capacitance                                     | $\text{C}_{\text{oss}}$                      | -    | 170    | -         |                     |   |
| Reverse Transfer Capacitance                           | $\text{C}_{\text{rss}}$                      | -    | 45     | -         |                     |   |

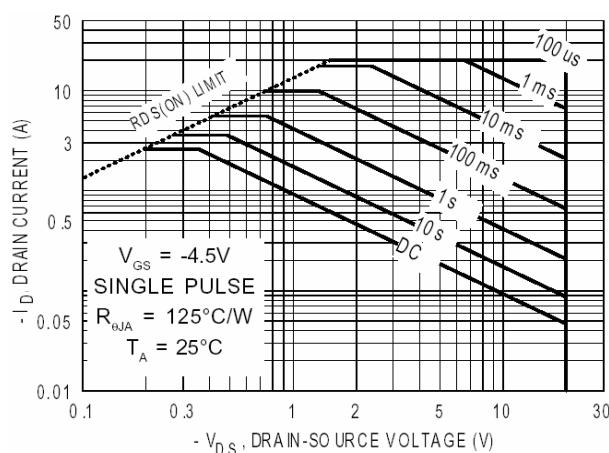
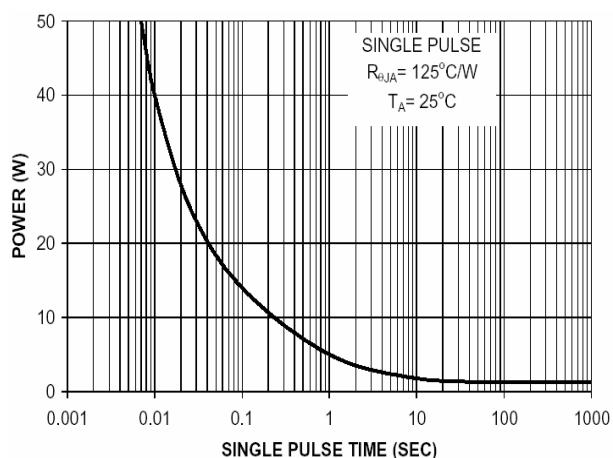
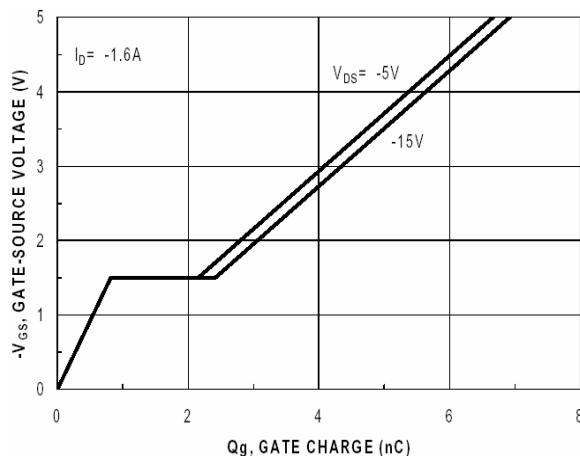
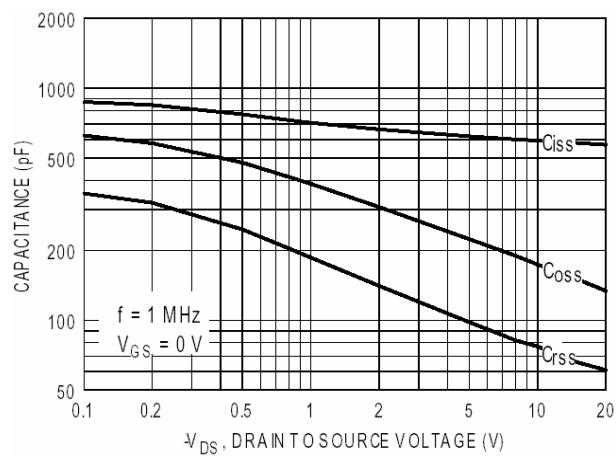
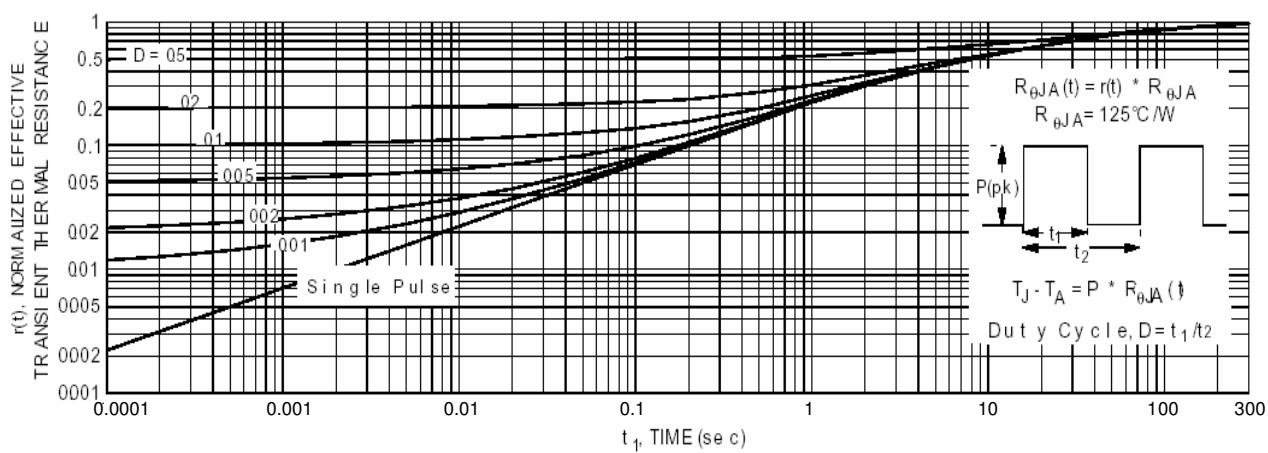
## Source-Drain Diode

| Parameter                              | Symbol                 | Min. | Typ. | Max. | Unit | Test Conditions   |
|--|------------------------|------|------|------|------|---|
| Forward On Voltage <sup>2</sup>        | $\text{V}_{\text{SD}}$ | -    | -    | -1.2 | V    | $\text{I}_S=-2.1\text{A}, \text{V}_{\text{GS}}=0\text{V}$                             |
| Continuous Source Current (Body Diode) | $\text{I}_S$           | -    | -    | -2.1 | A    | $\text{V}_{\text{D}}=\text{V}_{\text{G}}=0\text{V}, \text{V}_{\text{S}}=-1.2\text{V}$ |

Notes: 1. Pulse width limited by Max. junction temperature.

2. Pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .

**Characteristics Curve****Fig 1. Typical Output Characteristics****Fig 2. Transfer Characteristics****Fig 3. On-Resistance v.s. Drain Current and Gate Voltage****Fig 4. On-Resistance v.s. Junction Temperature****Fig 5. On-Resistance v.s. Gate-Source Voltage****Fig 6. Body Diode Characteristics**

**Fig 7. Maximum Safe Operating Area****Fig 8. Single Pulse Maximum Power Dissipation****Fig 9. Gate Charge Characteristics****Fig 10. Typical Capacitance Characteristics****Fig 11. Transient Thermal Response Curve****Important Notice:**

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